

October 4, 2023

**ELECTRONIC COPY** 

LABORATORY GROWN DIAMOND REPORT

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LG598394443 Report verification at igi.org

### LABORATORY GROWN DIAMOND REPORT

### **GRADING SCALES**

### CLARITY

IF	VVS <sup>1-2</sup>	VS <sup>1-2</sup>	SI <sup>1-2</sup>	l <sup>1-3</sup>
Internally	Very Very	Very	Slightly	Included
Flawless	Slightly Included	Slightly Included	Included	

### COLOR

D	Е	F	G	н	I	J	Faint	Very Light	Light

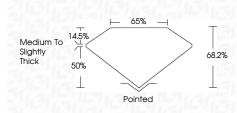


Sample Image Used

### LABORATORY GROWN DIAMOND REPORT

# October 4, 2023

OCIODEI 4, 2023	
IGI Report Number	LG598394443
Description	LABORATORY GROWN DIAMOND
Shape and Cutting Style	CUT CORNERED RECTANGULAR MODIFIED BRILLIANT
Measurements	7.02 X 5.03 X 3.43 MM
GRADING RESULTS	
Carat Weight	1.02 CARAT
Color Grade	E
Clarity Grade	VVS 2



#### ADDITIONAL GRADING INFORMATION

Polish	EXCELLENT
Symmetry	EXCELLENT
Fluorescence	NONE
Inscription(s)	(157) LG598394443
Comments: As Grown - No inc treatment. This Laboratory Grown Diamo Pressure High Temperature (Hi Type II	nd was created by High



Ť	LG598394443	IGI Report Number
50%	LABORATORY GROWN DIAMOND	Description
	CUT CORNERED RECTANGULAR MODIFIED BRILLIANT	Shape and Cutting Style
	7.02 X 5.03 X 3.43 MM	Measurements
		GRADING RESULTS
CLARITY CHARAC	1.02 CARAT	Carat Weight
	EL	Color Grade
	VVS 2	Clarity Grade
1XI-	FORMATION	

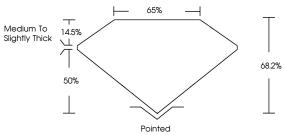
# ADDITIONAL GRADING INFORMATION

Polish	EXCELLENT
Symmetry	EXCELLENT
Fluorescence	NONE
Inscription(s)	1G1 LG598394443

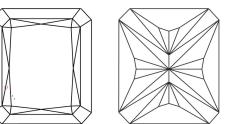
Comments: As Grown - No indication of post-growth treatment.

This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process. Type II

# PROPORTIONS



## CTERISTICS



### **KEY TO SYMBOLS**

Red symbols indicate internal characteristics. Green symbols indicate external characteristics.

www.igi.org

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